

*****Media Alert*****

Actel Discusses Power Management in Platform-based Systems MicroTCA Summit

Highlighting both challenges and solutions for emerging Micro Telecommunications Computing Architecture (MicroTCA) designs, Actel Corporation (Nasdaq: ACTL) will participate in an industry roundtable and a “chat with the experts” session at the upcoming MicroTCA Summit in Baltimore. At its booth (#34), Actel will demonstrate its Fusion-based MicroTCA Power Module in a MicroTCA chassis. The Fusion Programmable System Chip (PSC), Actel’s innovative mixed-signal field-programmable gate array (FPGA), delivers superior power management functionality in the smallest form factor available for MicroTCA management applications. Qualifying customers can register to receive Actel’s Power Module or Advanced Mezzanine Card (AMC) reference designs.

What/When: Roundtable: What Will it Take to Make Standard Platform-based System Development Succeed?
Speaker: Ian Land, senior manager, system solutions marketing, Actel
May 30, 5:00-6:00 p.m.

“Chat with the Experts”
Speaker: Ian Land, senior manager, system solutions marketing, Actel
May 31, 6:00-7:30 p.m.

Where: MicroTCA Summit
Sheraton Inner Harbor
Baltimore, MD

About MicroTCA Summit

The MicroTCA Summit program is designed to provide attendees with practical information on the current state of MicroTCA, the emerging standard platform for telecommunications equipment.

About Actel

Actel Corporation is the leader in single-chip FPGA solutions. The company is traded on the NASDAQ National Market under the symbol ACTL and is headquartered at 2061 Stierlin Court, Mountain View, Calif., 94043-4655. For more information about Actel, visit <http://www.actel.com>. Telephone: 888-99-ACTEL (992-2835).

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